

Title (en)

INSULATING COMPOSITION FOR PRINTED ELECTRONICS IN A CONDUCTOR INTERSECTION

Title (de)

ISOLATIONSZUSAMMENSETZUNG FÜR GEDRUCKTE ELEKTRONIK IN EINEM LEITERKREUZUNGSPUNKT

Title (fr)

COMPOSITION ISOLANTE POUR ÉLECTRONIQUE IMPRIMÉE DANS UN POINT DE JONCTION DE CONDUCTEUR

Publication

EP 2586278 A1 20130501 (DE)

Application

EP 11725778 A 20110620

Priority

- EP 10167011 A 20100623
- EP 2011060221 W 20110620
- EP 11725778 A 20110620

Abstract (en)

[origin: EP2400825A1] Insulation composition comprises at least an insulation spacer with an average particle diameter of at least 3-40 μ m. An independent claim is included for an electrical switching circuit comprising at least a substrate and at least an insulation layer.

IPC 8 full level

H05K 3/46 (2006.01)

CPC (source: EP)

H05K 3/4685 (2013.01); **H05K 3/1216** (2013.01); **H05K 2201/0209** (2013.01); **H05K 2201/2036** (2013.01)

Citation (search report)

See references of WO 2011161050A1

Designated contracting state (EPC)

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EP 2400825 A1 20111228; BR 112012032822 A2 20161108; CN 103098566 A 20130508; EP 2586278 A1 20130501; WO 2011161050 A1 20111229

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